EGP51A, EGP51B, EGP51C, EGP51D, EGP51F, EGP51G



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Vishay General Semiconductor

Glass Passivated Ultrafast Plastic Rectifier



PRIMARY CHARACTERISTICS						
I _{F(AV)}	5.0 A					
V _{RRM}	50 V, 100 V, 150 V, 200 V, 300 V, 400 V					
I _{FSM}	150 A					
t _{rr}	50 ns					
V _F	0.96 V, 1.25 V					
T _J max.	175 °C					
Package	DO-201AD					
Diode variations	Single die					

FEATURES

- Superectifier structure for high reliability condition
- · Cavity-free glass-passivated junction
- Ultrafast reverse recovery time
- Low forward voltage drop
- Low leakage current
- Low switching losses, high efficiency
- · High forward surge capability
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, and telecommunication.

MECHANICAL DATA

Case: DO-201AD

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)									
PARAMETER	SYMBOL	EGP51A	EGP51B	EGP51C	EGP51D	EGP51F	EGP51G	UNIT	
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	150	200	300	400	V	
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	V	
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	V	
Maximum average forward rectified current 0.375" (9.5 mm) lead length at T_L = 138.8 °C	I _{F(AV)}	5							
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	м 150							
Operating and storage temperature range	T _J , T _{STG}	-65 to +175							

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COMPLIANT

Revision: 22-Dec-16

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ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted)										
PARAMETER	TEST CONDITIONS		SYMBOL	EGP51A	EGP51B	EGP51C	EGP51D	EGP51F	EGP51G	UNIT
Maximum instantaneous forward voltage	5.0 A		V _F ⁽¹⁾	0.96			1.25		V	
Maximum DC reverse current at rated DC blocking voltage		T _A = 25 °C T _A = 125 °C	I _R ⁽²⁾	(2) <u>5.0</u> 50						μA
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	50						ns
Typical junction capacitance	4.0 V, 1	4.0 V, 1 MHz C _J		117			4	8	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: pulse width, \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)								
PARAMETER	EGP51A	EGP51B	EGP51C	EGP51D	EGP51F	EGP51G	UNIT	
Typical thermal resistance	R _{0JA} (1)(2)	55						°C/W
	R _{0JL} ⁽²⁾⁽³⁾	8.5						0/11

Notes

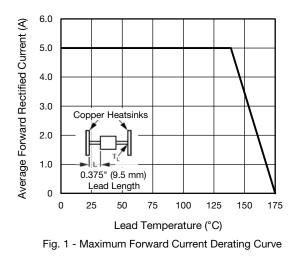
⁽¹⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{0JA}$

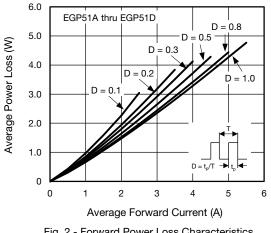
 $^{(2)}$ Thermal resistance $R_{\theta JA}$ - junction to ambient, $R_{\theta JL}$ - junction to lead at 0.375" (9.5 mm) lead length (use DC test method)

⁽³⁾ Device mounted on 30 mm x 30 mm PCB pad size areas.

ORDERING INFORMATION (Example)									
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE					
EGP51G-E3/C	1.21	С	1400	13" diameter paper tape and reel					
EGP51G-E3/D	1.21	D	1000	Ammo pack packaging					

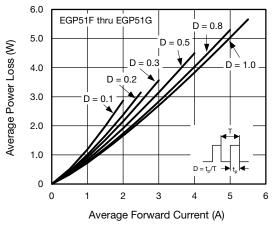
RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)





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Fig. 3 - Forward Power Loss Characteristics

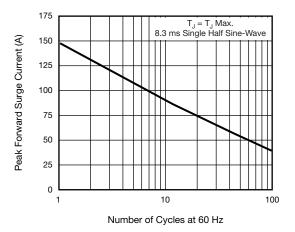


Fig. 4 - Maximum Non-Repetitive Peak Forward Surge Current

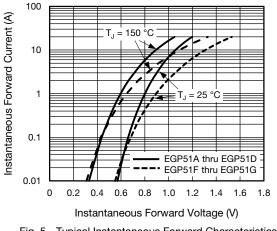


Fig. 5 - Typical Instantaneous Forward Characteristics

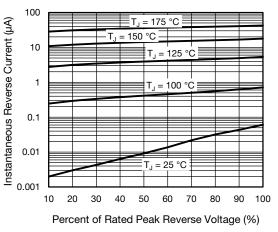


Fig. 6 - Typical Reverse Leakage Characteristics

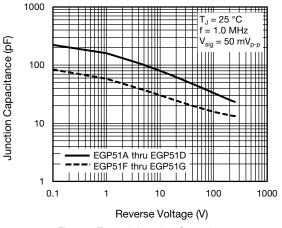


Fig. 7 - Typical Junction Capacitance

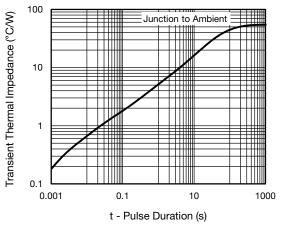


Fig. 8 - Typical Transient Thermal Impedance

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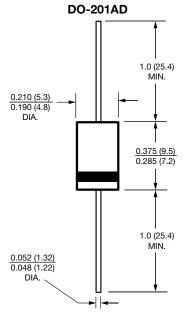
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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